R&D Opportunities in Linear Collider Tracking

Cornell University LCCOM 19-April-2002

Baseline Detectors Momentum resolution and implications Jet track density and implications

Resolution and segmentation in various technology, R&D issues

TPCs drift chambers / jet chambers (baseline in Asia, not considered in N.A. or Europe) new technology gas amplification TPCs all silicon trackers

Simulation work

Physics Goals, Implications

clean Higgs signal from di-lepton recoil mass end-point mass spectra in SUSY cascades

 $d(1/P_t) \sim \text{few } 10^{-5} / \text{GeV}$

jet energies in W+W- final states (energy flow analysis)

exceptional pattern recognition, 2-track separation

Primary and secondary vertex reconstruction

radially continuous tracking

The large detector baseline design, LD

Goal=optimi>ed tracking precision with large tracking volume

Magnetic field=? Tesla



North American LD baseline design Stolen from K. Riles, Chicago Linear Collider Workshop, 7-Jan-2002

The silicon detector baseline design, D

Energy flow calorimetry -@ Expensive calorimeter -@ Small calorimeter -@

Limit tracking system Outer radius to 125 cm

Compensate for a smaller measurement length

with improved spatial resolution (although fewer points) and higher magnetic field

Magnetic field=5 Tesla



North American SD baseline design Stolen from K. Riles, Chicago Linear Collider Workshop, 7-Jan-2002

TESLA trac ing system **1.7m** Magnetic field=B Tesla FCH TPC **1**m SIT $\cos(\theta)$ F.995 FTD Stolen from TESLA TDR VTX 2.73 m 1m2m

(differences, wrt North American LD)

1.A m radius (vs 2 m), B Tesla field (vs ? Tesla in N.American LD) SCT is an intermediate tracking device, 2 layers DCH is a straw tube device, E double layers, resolves TESLA bunch (?B0 ns)



oment m esol tion

 $\delta(1/p_t)$ F goal is difficult with tracking chamber and vertex detector alone.

Try an intermediate silicon device, RF.B5 meter, σ_{r_0} F 10µm, NF2

(relaxed) PHYSCCS GOAL= $\delta(1/p_t)$ FB x 10 ⁻⁵ / GeV

(relaxed) magnetic field= ? Tesla

Tracker= 2m OR , 0.5m GR Vertex detector=5 layer, 10 μm

tracker 100 μm ----à $\delta(1/p) F$?.5 x 10^{-5} /GeV with VD and int. tracker

tracker 150 μm ----à $\delta(1/p) F$ B.2 x 10^{-5} /GeV with VD and int. tracker

I Results from Dan s fast MC

tracker 150 μ m ----à $\delta(1/p)$ F E.0 x 10⁻⁵ /GeV with VD and int. tracker (misaligned by 25 μ m, 1 mil)

patial esol tion

Spatial resolution reKuirement is aggressive, $100 \ \mu m$ in 5 Tesla field.

(This result is for a **large chamber** (rF2 m) in combination with a **perfect vertex detector** which constrains the fit at the vertex.)

Momentum resolution goal can be met with 150 μ m in ? Tesla field.

(This result is for LD, a large chamber (rF2 m) with

a vertex detector and intermediate detector , both σ F 10 μm) However, the resolution is sensitive to misalignments .

Large TPCs do not meet either spatial resolution goal. Dor example,

Aleph= σ F 1L0 μ m, STAR = σ F 500 μ m. This resolution is partially related to the pad spacing, which comes with the induction readout. Aleph resolution is ?M of the pad spacing (E.2 mm).

STAR resolution is L-1AM of the pad spacing (E.2 or 2.9 mm).

Drift chambers can provide 100 μ m spatial resolution. Let *s* see what else is a problem N.

Trac Density

This GrypicalHjet has 19 tracks projected onto an a>imuthal angle of ?0^o. This is a track density of LL tracks/ster (for conical jets).

Cwill use tracks/ster as pattern recognition goal.



JAS 2D LCD Event Display Stolen from N. Graf, Chicago Linear Collider Workshop, 7- Jan-2002

"ompare #ith the T\$ TP"





③ 100 tracks/ster largeO Yes, that would be 1250 tracks in the event.
STAR observes 1000 to 2000 tracks per event.
③ this demonstration that a TPC can operate with this track densityO

No, perfect efficiency is not a goal at STARPlook at those panel cracksQ Spatial resolution reKuirement is relaxed P σ F 500 μm . Must do betterQ

TPC

egmentation and Occupancy

(induction read-out)

segmentation is limited by
the signal time width,
but usually by the R travel of the track.
R segmentation is typically eKual to
height of the pad, 10mm O20 mm O



r \$\$\phi\$ segmentation is limited by the induction read-out.
 (Gas amplification is due to an avalanche on a wire.
 Chduction signals on pads are read out.)
 STAR signal width, 2-track separation= 25 mm.

cc panc =at rF 50 cm,

with r- ϕ segm.F 2.5 cm, R segm. F 1 cm, segmentation is 1/1000 sterP occupancy (in jet) is 10M, there will be overlapping tracks



Overlapping tracks are complicated in a TPC.

Pulse height signals on pads can not be resolved beyond the intrinsic segmentation of the device.

Merged signals have ambiguous position measurement $P@@\sigma$.

Two tracks in STAR TPC Stolen from J. Thomas, Vienna Conference on Instrumentation , 22-Feb-2001

! D pro'ects, TPC (induction) trac er

The (induction) TPC is the baseline, or backup, for advanced readout methods (described later).

Spatial resolution optimi>ation, goal of 150 μm in a large induction TPC. On feedback suppressionPgating grids (long gate time at TESLA) Gas studies=aging, velocity (clearing time), Kuenching, neutron absorption

Alignment=

internal alignment and drift path in an inhomogeneous B field extrapolation to an intermediate tracker= hardware & tracking. (with poorer resolution, system is more dependent on intermediate tracker)

(simulation)

Optimi>e pattern recognition in an environment of significant track overlap.

Drift Chambers

Drift chambers are largely not considered by North America and Europe groups.

Disadvantages=

@oor segmentationH(discussion follows)
wire sag and electro-mechanical instability
wire tension load on endplate, endplate thickness
Lorent> angle in a high magnetic field
current limitation

Drift Chamber (Jet) is the baseline design in Asia.

Advantages=

spatial resolution=LL μ m for LOM of hits (CLEO) 2-track separation better than segmentation (will discuss for 1B mm sKuare cell design)



Trac %&erlap in a s(are cell dri) t chamber

Ch drift chambers, there is no R segmentation. jet track density=19 tracks/?0° ?E tracks/radian 0.A tracks/cm at RF 50 cm

Within the orange circle= ? tracks within 2 cell widths (note separation= yellow circle). Observed density=

1.1 tracks/cm

55 tracks/radian at RF 50 cm

Tracks are resolved **p to** this density if sufficient separation exists elsewhere on the track.



CLEO MC event

Trac %&erlap in a s(are cell dri) t chamber, resol&ed

Multi-tracks <u>can</u> be resolved beyond the device intrinsic segmentation because the time measurement is

valid for one of the tracks.

(some of the hits, all the time)

Method involves extrapolating in from isolated hit region.

Track separation is better than intrinsic segmentation.

Applies to Jet Chamber.



Display of hit residuals (hori>ontal) of hits on a track (in white on prev. slide).

Jet Chambers

- Jet chamber=B mm segmentation (a 2 mm track separation, measured in a single layer, is doubled by the ambiguity)
- (while the sKuare cell example had 1B mm segmentation)

Track separation is better than the B mm segmentation as shown for the case of sKuare cell chamber.

Disadvantage=

discontinuous tracking due to complicated field cage shaping

Expect a track density **limit** of 1 track/Bmm at RF 50 cm 125 tracks/radian



CDF Jet Chamber event Stolen from Y-K Kim, 2001 Lepton Photon Symposium , 23-July-2001

! D , * et " hamber, ongoing/planned (SES)

+I #ill disc ss these ! D res Its,-Wire sag and electro-mechanical instability 2-track separation Lorent> angle (and drift velocity) Spatial resolution

nderstood at "L. % Stable operation of stereo cells
 Aluminum wire creep

H #ill not disc ss res Its/ plans in-Gas gain saturation (affects dE/dx, 2-track separation) Neutron backgrounds Optimi>ation of gas mixture

+#hat sho ld be st died-

Careful study to reconstruction vs track density with full MC.

* et " hamber0 #ire sag, electro1mechanical instability

5 sense wires/cell, A cm height
5 cm drift
Note=triple field wire will reduce instability

Wire positions measured with CCD cameras.

Sense wire sag= $\sim ?00~\mu m$, field E00 μm Motion with voltage on minimal, no instability observed







Stolen from JLC website, N. Khalatyan, Tsingua

* et " hamber 21trac separation

Small jet cell chamber in test beam e⁺e⁻ pairs from conversions

DADC signals analy>ed for separation

Observe 2 mm separation







Stolen from JLC website, K. Fujii, FermiLab 2000





Advantages=electron collection, 100 μm spacing Signal width is significantly reduced, improved segmentation E x B effect (in radial part of electric field) which limits resolution in an induction readout is reduced with signal width

Problems=

New technology

Signal width may be too small.

Must extract optimum resolution with finite T of channels.

Gem TPC read-out Stolen from TESLA TDR

Signal size in GEM and induction read-out

Stolen from M. Ronan, Vienna Conf. on Instrumentation, 22-Feb-2001

! D, TP" , G. / icro . G\$ read10 t

Pad si≫=narrow electron cloud ~ 1mm reKuires 1mm pads to provide charge sharing, %(10^E) pads wider pads (5mmQ) will have poor resolution=w/(12)^{1/2}

Pad shape=methods of spreading signal to limit channel count and improve resolution chevronsO gangingO @ductionO Beware, efforts to spread signal may compromise 2-track separation.

Aging=GEMs can fail at high gain, relatively new technology, dependence on gas choice

Gas=diffusion, velocity

Active R&D

Achen, Carleton/Montreal, DESY/Hamburg, Sarlsruhe, Srakow, LBNL, MCT-Munich, MPC, NUSHED, Novosibirsk, Orsay/Saclay, Purdue

G. point resol tion, "arleton

U-ray incident on indicated point. (not a TPC)

Charge shared signal is observed on ? pads (2.5 mm hex).

Direct charge collection signal has about 1 μ s width, 10 MH>

Charge sharing contours (lower right) indicate that signal width is 1 mm.

Spatial resolution is V 100 $\mu\text{m},$ but only 1mm from boundaries.



Localization from charge sharing



X-ray signal spatial resolution Stolen from D. Karlen , Chicago Linear Collider Workshop, 7-Jan-2002

G. point resol tion +ind ction-, "arleton

Also measured induction signals on B neighboring pads. (same event)

Spatial resolution is V 100 μ m and <u>not</u> dependent on 1 mm pad si>e.

Signal width (threshold-threshold) 0.1 μ s, reKuires 50-100 MH>

However, induction is inconsistent with 2-track separationP could be used in isolated sections to improve resolution.



TP" #ith G. ead1o t, "arleton





Explanation=large diffusion contribution (no magnetic field) Extrapolates to 200 µm at >F0 Wuestions= ion statistics O (5 mm pad height)

anomalous electron cloud si \geq O



Cosmic signal spatial resolution Stolen from D. Karlen , Chicago Linear Collider Workshop, 7-Jan-2002

Example triple GEM with PCB readout

Gas Ar/CO₂ A0/?0 (99.99M)

- GEM1F B00 V GEM2F ?90 V GEM? F?L0 V PCB as e⁻ collector
- Cr U-rays (5.B SeV) X E x 10^{B} H>/mm² for A50hrs

Gas gain E,000

Detector performance small (~15M gain loss) after ~ L years X LHC 10 cm from (P). No visual sign of aging.

Best result obtained with a GEM.



Stolen from I. Shipsey, NIM A 478 (2002) 263

! D, TP", G. / icro . G\$ read10 t, cont,

Tests in high magnetic field=reduce transverse diffusion, surprises

Electronics=sampling rate, Aleph=11 MH>, 100 Mh> reKuired for faster gas or induction from neighboring pads Typical live time may be 50 μ s, store 1 ms exposure at TESLA.

Amplification=signal si>e, break-down limit, pad height, gas

Mechanical=mounting gas amplifiers, minimi>ing inactive regions high speed sampling may reKuire cooling

(and, as in induction read-out TPC) On feed-back=multi-GEMs or MicroMEGAS (appears better) and/or gating grid

Gas=Kuenching with hydrocarbons vs neutron cross section

Alignment methods=internal, external, consistant with improved resolution (and, in an inhomogeneous magnetic field)

\$11 ilicon Trac ing



 $\begin{array}{l} \mbox{Provides= improved segmentation} \\ & \delta(1/P_t) \mbox{ in a small package} \\ \mbox{Diasadvatages=} \\ & \mbox{pattern recognition issues} \\ & \mbox{material issues (low momentum)} \\ & \mbox{limited dE/dx} \end{array}$

2 technologies being pursued by North American groups Silicon μ -strip Silicon Drift



Stolen from B Schumm, SILC phone/web meeting, 4-Apr-2002

! D , all silicon trac ing

Organi>ational meeting=April B, Bruce Schumm, UCSC

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Silicon µ-strip=R&D, UC Santa Cru>
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reduce material, detectors must be very thin, 200 μ m + no support (CLEO ?00 μ m plus support) to compete with budget of TPC (1.?M U_o in inner support)

long shaping time, allows ultra low noise for thin detectors, 10 μs (CLEO V? μs)

minimal support material, possibly tensioned

power cycling, reduce heat load, can this be done without adding noiseO

resolution, 50 μ m pitch with centroid finding for reKuired A μ m

Silicon Drift = R&D, Wayne State (next page)

ilicon Dri) t Detector

Electron drift in silicon, r- ϕ from pad, > from drift time Maximum drift=5 μ s

Mature technology, STAR vertex detector

LC Central tracker Dive layers

Goals= Radiation length / layer F 0.5 M σ (r- ϕ) F A μ m, σ (>) F 10 μ m

Wafer si>e=10 by 10 cm Wafers=E000 (incl. spares) Channels=B,B0B,BL0 (2E0 µm pitch)

Stolen from V. L. Rykov , Chicago Linear Collider Workshop, 7-Jan-2002





! D, silicon dri) t detector

Ongoing/planned at Wayne State

Comprove radiation length, STAR is 1.B M per layer Reduce wafer thickness from ?00 to 150μm Move DEE to edges or change from hybrid to SVU Air cooling vs. water cooling

More extensive radiation damage studies. Detectors/DEE can withstand around 100 krad (γ,n)

Comprove position resolution to 5μ m Decrease anode pitch from 250 to 100μ m.

Stiffen resistor chain and drift faster. PASA is BOPOLAR (intrinsically rad. hard.) SCA can be produced in rad. hard process Intermediate trac er, 50r#ard Dis s

Motivation=improve momentum resolution extend efficiency to $cos(\theta)F.995$

Technology=spatial resolution goal reKuires silicon technology pixel devices or the silicon devices proposed for all silicon tracking

Performance Gsues=many tracking studies to optimi>e performance and prove effectiveness (below)

Mechanical Gsues= solve mounting problems. Structures must be rigid and aligned to the central tracker, (note=degraded resolution for 25 µm misalignment) yet independent of central tracker (for access).

! D , physics moti&ation

Physics motivation studies will reKuire a DAST Monte Carlo.

Momentum resolution=realistic reKuirements (point of diminishing returns) for Higgs recoil mass and slepton endpoint spectrum, taking into account other width contributions= particle decay widths, initial state radiation, beam energy spread.

Material budget=realistic reKuirements, compelling physics example that determines the material limit, What $\delta p/p$ is reKuired at 1 GeV/c O What photon conversion rate is unacceptable O

dE/dx = Compelling physics example where dE/dx make a difference.

! D , system per) ormance / pat, rec,

System performance studies will reKuire a DULL Monte Carlo. including alignment errors, efficiency, detector response function, noise from multiple bunches, backsplash, beam

Performance enhancers=

intermediate silicon tracking layer=

how much does this help for pat. rec. , $\delta p/p$ O intermediate scintillating fiber layer (timing, bunch tagging) outer > layer (extrapolation into calorimeter) outer end-cap tracker ($\delta p/p$ at low θ)

Performance in very high noise environment=(higher than expected 1M)

Performance with large electric field distortion (TPC) due to space charge (although GEM/MicroMEGAS proponents confident that ion feedback will be suppressed, maybe with gating grid and primary ioni>ation is claimed sufficient for expected accelerator backgrounds)

Wire saturation=(in a drift chamber) from larger than expected accelerator backgrounds, degrades time resolution, efficiency

! D, pattern recognition iss es

reKuires DULL Monte Carlo as on previous slide.

Mature pattern recognition that performs in high density environment (which might include) Non-linear methods=allowing for global determination of the ambiguity arising from different matching of high-Kuality track-segments

Energy Dow Performance=

realistic comparison of track separation performance ?D and 2D, silicon and gas options TPC with induction *vs* GEM/MicroMEGAS, GEM with induction evaluate (charge spreading) pad design for track separation

Silicon tracking=demonstrated Gtand-aloneHtrack reconstruction,

Y for Gall siliconHtracking options

including reconstruction of decays in flight

(fewer, more precise, hits vs continuum of less precise hits)

- Y for silicon forward discs
- Y for vertex detector, including self contained tracking GeedsH successfully extrapolated into the outer tracker

TPC

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R & D opportunities in Tracking

extrapolation to an intermediate tracker= hardware & tracking. Optimi>e pattern recognition in an environment of significant track overlap. Advanced readout TPC

Pad si>e= narrow electron cloud ~ 1mm

reKuires 1mm pads to provide charge sharing, $%(10^{E})$ pads wider pads (5mmQ) will have poor resolution=w/(12)^{1/2} Pad shape=methods of spreading signal to limit channel count and improve resolution chevronsO gangingO @ductionO

Amplification=signal si>e, break-down limit, pad height, gas Gas=further studies studies=diffusion Tests in high magnetic field=reduce transverse diffusion, surprises Electronics=sampling rate, Aleph=11 MH>, 100 Mh> reKuired for faster gas or induction from neighboring pads Typical live time may be 50 μ s, store 1 ms exposure at TESLA. Aging=GEMs can fail at high gain, relatively new technology, dependence on gas choice Mechanical=mounting gas amplifiers, minimi>ing inactive regions high speed sampling may reKuire cooling Silicon µ-strip tracker reduce material, detectors must be very thin, 200 μ m + no support to compete with budget of TPC (1.?M U₀ in inner support) long shaping time, allows ultra low noise for thin detectors, 10 µs minimal support material, possibly tensioned power cycling, reduce heat load, can this be done without adding noiseO resolution, 50 um pitch with centroid finding for reKuired A um Silicon drift Onprove radiation length, STAR is 1.B M per layer, reKuire 0.5M radiation damage studies. On prove position resolution to $5\mu m$. Decrease anode pitch from 250 to $100\mu m$. Simulations Momentum resolution=realistic reKuirements for Higgs recoil mass and slepton endpoint spectrum, Material budget=realistic reKuirements, compelling physics example that determines the material limit, dE/dx = Compelling physics example where dE/dx make a difference. Performance enhancers= intermediate silicon tracking layer= how much does this help for pat. rec., $\delta p/p$ O intermediate scintillating fiber layer (timing, bunch tagging) outer > layer (extrapolation into calorimeter) outer end-cap tracker ($\delta p/p$ at low θ) Performance in very high noise environment=(higher than expected 1M) Performance with large electric field distortion (TPC) due to space charge Wire saturation=(in a drift chamber) from larger than expected accelerator backgrounds, degrades time resolution, efficiency Mature pattern recognition that performs in high density environment Energy Dow Performance= realistic comparison of track separation performance ?D and 2D, silicon and gas options Silicon tracking= Gtand-aloneHtrack reconstruction, for Gll siliconHtracking options, silicon forward discs vertex detector



A TPC is not a trigger device.

Although the maximum drift is about 50 μ s, data collected throughout the entire train width (950 μ s at TESLA) must be stored in the electronics, 20,000 time buckets/channel at 20 MH>. Compress data during train.

A Drift Chamber is sensitive to the same amount of radiation (one train) as a TPC in NLC/JLC. TPC segmentation provide noise immunity. However, a drift chamber would have reduced beam noise at TESLA.